ASSY Configuration Codes (Binary OR) **Test Point List** Number 1 case Function R65 is placed to allow OFFVCC to shutdown the SupMCU; R65 is not placed, protecting the SupMCU from OFFVCC; -RST Reset Input to the SupMCU TP8 RI9 is not placed, protecting the SupMCU from -RESET; RI9 is not placed, protecting the SupMCU from -RESET; R4 is placed connecting CLK0 and CLKOUT; Using bus flight switches, place JP1, JP2, JP4, JP5; Bypassing flight switches, place JP3 and JP6; R19 is placed, allowing -RESET to reset to SupMCU: TP9 +5V SYS System 5V Supply R4 is not placed, separating CLK0 for CLKOUT; TP15 GND System Ground Not bus flight switches; Not bypassing flight switches; GND System Ground 3 TP16 System Ground 4 16 TP17 GND Large and 1753 and 1763. Using PCB mount thermistors, place TF3 and TF3; 1150mA charging current, place R30 and R39 as 1.5K resistors; AGND connection is made, place R34; Place Through-hole components B1-4, H1-2, J253, K1-3, J1; Using External Thermistors DNP TS1 and TS2; 32 TP35 VBATT System Battery Voltage Supply 750mA charging current, place R30 and R39 as 2.49K resistors; AGND connection is not made; Positive terminal of Battery A 64 TP36 BATT A+ 128 TP37 BATT B+ Positive terminal of Battery B Module 4.8V Supply Voltage 256 No Through-hole components are placed; TP38 +4.8V TP39 +4.8V SW Battery Charging Supply Voltage TP40 +5V EPS Module 5V Regulated Supply Module 3.3V Regulated Supply TP41 +3.3V_EPS TP42 VCC_SYS System 3.3V Supply **ECO List**

MOD Level	Number	Action Summary

Changes from REVD0

Designed in Altium
Changed to PIC24 based SupMCU achitecture
Added better current measurement
Changed thermistor/heater connections
Simplified SupMCU Bus interface to I2C only
Added USB FTDI functionality

+3.3 <u>V_</u> EPS	
0	TP41
+5V_EPS	
+4.8V_SW	TP40
Т	TP39
1 7.0 1	
VCC_SYS	TP38
T	mp. 10
+5V_SYS	TP42
•	TP9
VBATT	
	TP35
	TP15
•	TP16
•	TP17
— GND	

1 2 3 4 5 5 6 Drawn By: DJW